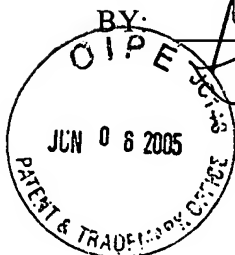


I HEREBY CERTIFY THAT THIS CORRESPONDENCE IS BEING DEPOSITED WITH THE UNITED STATES POSTAL SERVICE AS FIRST CLASS MAIL IN AN ENVELOPE ADDRESSED TO: COMMISSIONER FOR PATENTS, P.O. BOX 1450, ALEXANDRIA, VA 22313-1450, ON THE DATE INDICATED BELOW.

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Date:



MAIL STOP AMENDMENT

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Patent Application of:

Yuan-Chang Huang

Conf. No.: 8636

Group Art Unit: 2811

Appln. No.: 10/717,355

Examiner: Hung K. Vu

Filing Date: November 19, 2003

Attorney Docket No.: 681954-65US
(P03920003US)

Title: CONDUCTIVE BUMPS WITH INSULATING SIDEWALLS (as amended)

AMENDMENT

This Amendment is being filed in response to the Office Action dated December 2, 2005 and is being filed within the third month after the shortened statutory period set for a response to the Office Action. A Petition for a three month extension of time accompanies this paper. If any additional fees are due, charge the fees to Deposit Account No. 50-1017 (Billing No. 681954.0065).

Amendments to the Title begin on page 2 of this paper.

Amendments to the Claims begin on page 3 of this paper.

Amendments to the Abstract begin on page 6 of this paper.

Remarks and Conclusion begin on page 7 of this paper.

Application No. 10/717,355
Reply to Office Action of December 2, 2004

Amendments to the Title:

On page 1, delete the original Title in its entirety and replace it with the following new
Title:

Conductive Bumps Formed as Unitary Structures with Insulating Sidewalls and Directly
Exposed Top Surfaces